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Application Specific Discretes TRANSIENT VOLTAGE SUPPRESSOR A.S.D.™ FOR SLIC PROTECTION

FEATURES

- DUAL ASYMETRICAL TRANSIENT SUPPRESSOR
- PEAK PULSE CURRENT : IPP = 40A, 10/100μs
- HOLDING CURRENT : 150 mA min.
- BREAKDOWN VOLTAGE : 65 V min.
- LOW DYNAMIC CHARACTERISTICS
- STAND CCITT K20 AND LSSGR

DESCRIPTION

This device has been especially designed to protect subscriber line cards against overvoltage.

Two diodes clamp positive overloads while negative surges are suppressed by two protection thyristors.

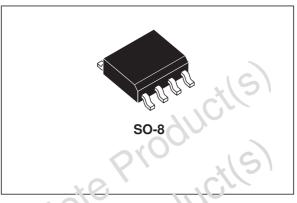
A particular attention has been given to the internal wire bonding. The "4-point" configuration ensures a reliable protection, eliminating overvolucies introduced by the parasitic inductances on the wiring (Ldi/dt), especially for very fast transient overvoltages.

COMPLIES WITH THE FOLLOWING STANDARDS :

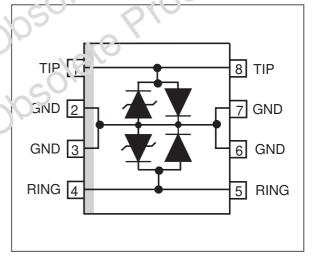
10/700µs	ткV
5/310µs	38А
1)/762μs	2kV
5/310μs	50A
1.2/50μs	1.5kV
1/20μs	40A
0.5/700μs	1kV
0.2/310μs	38A
2/10μs	2.5kV
2/10μs	125A (*)
2/10μs	2.5kV
2/10μs	125A (*)
10/1000μs	1kV
10/1000μs	40A (*)
	5/310μs 1.2/50μs 1.2/50μs 1/20μs 0.5/700μs 0.2/310μs 2/10μs 2/10μs 2/10μs 1/20μs 1/20μs

(*) with series resistors or PTC.

August 2001 - Ed: 2



SCHEMATIC DIAGRAM

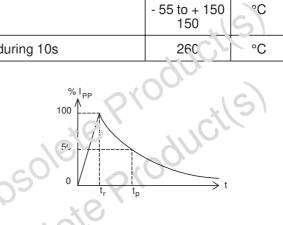


Symbol	Parameter	Value	Unit	
Ірр	Peak pulse current (see note 1)	10/1000μs 5/310μs 2/10μs	40 50 125	A
I _{TSM}	Non repetitive surge peak on-state current F = 50 Hz	t = 300 ms t = 1 s t = 5 s	10 3.5 1	A
I _{TSM}	F = 50 Hz, 60 x 1 s, 2 mn between pulse		1	Α
T _{stg} Tj	Storage temperature range Maximum junction temperature		- 55 to + 150 150	°C
T_L	Maximum lead temperature for soldering during 10)s	260	°C

ABSOLUTE MAXIMUM RATINGS (T_{amb} = 25°C)

Note 1 : Pulse waveform :

- $10/1000\mu s$ $t_r=10\mu s$ t_r=5µs 5/310µs t_r=2μs 2/10µs
- t_p=1000μs t_p=310μs t_p=10μs



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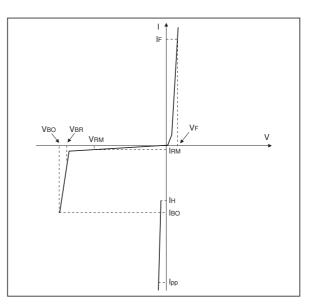
THERMAL RESISTANCES

Symbol	Parameter	Value	Unit
R _{th (j-a)}	Junction to ambient	170	°C/W

ELECTRICAL CHARACTERISTICS

 $(T_{amb} = 25^{\circ}C)$

	Symbol	Parameter
	VRM	Stand-off voltage
	Ur.M	Leakage current at stand-off voltage
	V _{BR}	Breakdown voltage
	V _{BO}	Breakover voltage
	H	Holding current
~	VF	Forward voltage drop
	V _{FP}	Peak forward voltage
	I _{BO}	Breakover current
	IPP	Peak pulse current
	С	Capacitance
	αΤ	Temperature coefficient



1 - PARAMETERS RELATED TO DIODE LINE / GND

Symbol	٢	Test conditions	Min.	Тур.	Max.	Unit
VF	$I_F = 1 A$	tp = 100 μs			2	V
V _{FP}	see curve fig. 1		NA	NA	NA	V

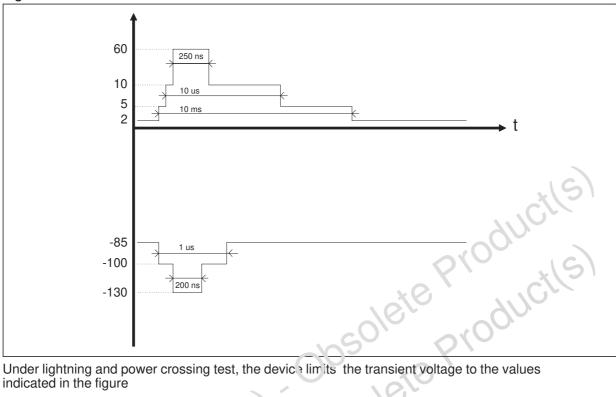
NA : Non Available

2 - PARAMETERS RELATED TO PROTECTION THYRISTOR

$ \begin{array}{ c c c c c c } \hline V_{BR} & I_{R} = 1mA \\ \hline V_{BO} & & \\ \hline I_{RM} & V_{RM} = 63 \ V \\ \hline I_{BO} & tp = 100 \ \mu s \\ \hline I_{BO} & F = 50 \ Hz \\ RG = 600 \ \Omega \\ \hline I_{H} & & \\ \hline \alpha T & & \\ \hline C & V_{D} = 100 \ mV_{RMS} F = 1 \ KHz \\ \hline dV/dt & Linear ramp up to \ 67 \ \% \ cf \ V_{B'A} \\ \hline \end{array} $	65 68 110 150 5	15	35 100 450 500 500	V V μA mA mA 10 ⁻⁴ /°C pF
I _{RM} V _{RM} = 63 V I _{BO} tp = 100 µs I _{BO} F = 50 Hz RG = 600 Ω I _H α T C V _D = 100 mV _{BMS} F = 1KHz	110 150	15	100 450 500	μA mA mA 10 ⁻⁴ /°C
IBO tp = 100 μs IBO F = 50 Hz RG = 600 Ω IH α T C VD = 100 mVBMS F = 1KHz	150	15	450 500	mA mA mA 10 ⁻⁴ /°C
$I_{BO} = 50 \text{ Hz}$ $RG = 600 \Omega$ $I_{H} = 600 \text{ MV}$ $RG = 100 \text{ mV}$ $F = 1 \text{ KHz}$	150	15	500	mA mA 10 ⁻⁴ /°C
$RG = 600 \Omega$ H αT C $V_D = 100 mV_{BMS}$ $F = 1KHz$	ete	15		mA 10 ⁻⁴ /°C
αT C VD = 100 mVBMS F = 1KHz	ete	15	500	10 ⁻⁴ /°C
С V _D = 100 mV _{BMS} F = 1КНz	5	15	500	
C V _D = 100 mV _{RMS} F = 1KHz dV/dt Linear ramp up to 67 % cf v _B ?	5		500	nE
dV/dt Linear ramp up to 67 % cf ver	5			pi
lete Product(s) Obs				kV/μs
psolete prov.				

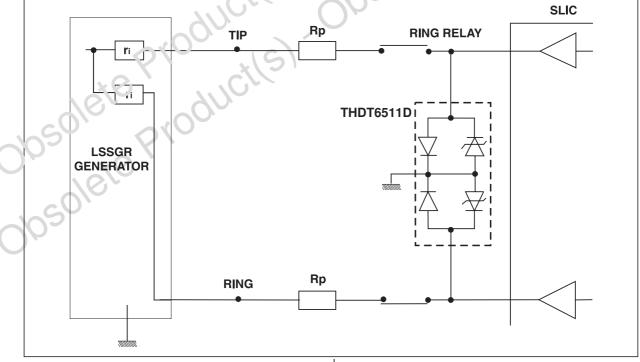
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DYNAMIC CHARACTERISTICS : V_{FP} and V_{BO} Figure 1 :



Under lightning and power crossing test, the device limits the transient voltage to the values indicated in the figure

LSSGR TEST DIAGRAM Figure 2 :

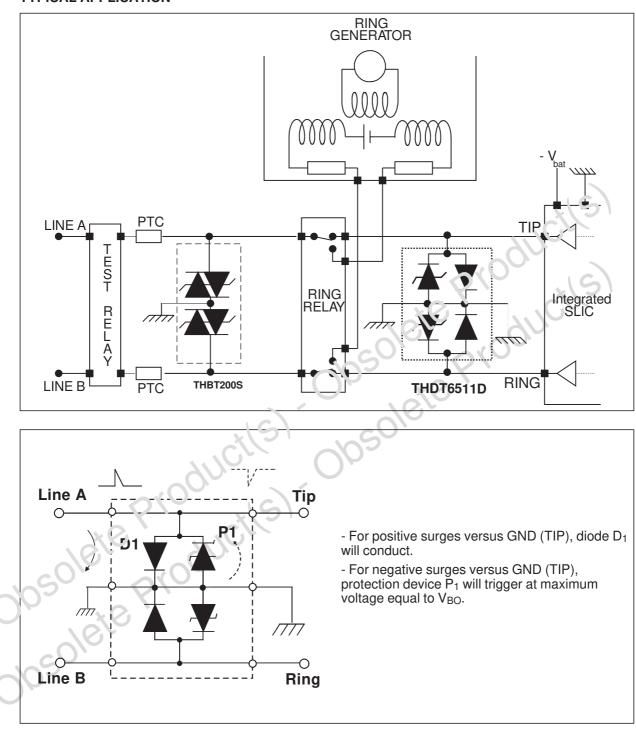


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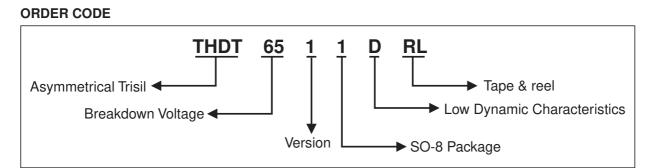
To stand the LSSGR test requirements, Rp must be | 15 Ω

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PACKAGE MECHANICAL DATA. SO-8 Plastic

		DIMENSIONS					
	REF.	Millimetres		Inches		j	
		Min.	Тур.	Mrix	Min.	Тур.	Max.
	А			1.75		×	0.069
	a1	0.1	.0.	0.25	0.004	C 22	0.010
	a2	10		1.65			0.065
	b	0.35		0.48	0.014		0.019
	<u></u> 1	<u>u.19</u>		0.25	0.007		0.010
	C		0.50			0.020	
	c1		10	45°	(typ)		
	D	4.8	1	5.0	0.189		0.197
8 5	E	5.8		6.2	0.228		0.244
F	е	2	1.27			0.050	
	e3		3.81			0.150	
	F	3.8		4.0	0.15		0.157
	L	0.4		1.27	0.016		0.050
Y' *(3)	М			0.6			0.024
	S			1) °8	nax)		

MARKING : DT651D

CKAGING : Products supplied in antistatic tube or tape and reel.

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Weight: 0.08g